

## NC7SZ66

### TinyLogic® Low Voltage UHS Single SPST Normally Open Bus Switch

#### General Description

The NC7SZ66 is a ultra high-speed (UHS) CMOS compatible single-pole/single-throw (SPST) bus switch. The LOW On Resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and Port A is connected to Port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports.

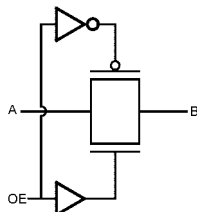
#### Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Broad  $V_{CC}$  Operating Range 1.65V–5.5V
- Rail-to-rail signal handling
- $5\Omega$  switch connection between two ports
- Minimal propagation delay through the switch
- Low  $I_{CC}$
- Zero bounce in flow-through mode
- Control input compatible with CMOS input levels

#### Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZ66M5X	MA05B	7Z66	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7SZ66P5X	MAA05A	Z66	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7SZ66L6X	MAC06	EE	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

#### Logic Symbol



#### Pin Descriptions

Pin Names	Description
OE	Switch Enable Input
A	Bus A I/O
B	Bus B I/O
NC	No Connect

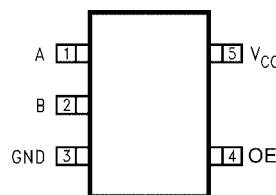
#### Function Table

OE	$B_0$	Function
L	HIGH-Z State	Disconnect
H	$A_0$	Connect

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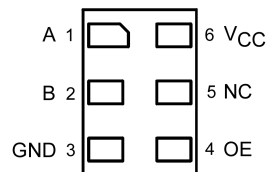
#### Connection Diagrams

Pin Assignments for SC70



(Top View)

Pad Assignment for MicroPak



(Top Through View)

**Absolute Maximum Ratings** (Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Switch Voltage ( $V_S$ )	-0.5V to $V_{CC} + 0.5V$
DC Input Voltage ( $V_{IN}$ ) (Note 2)	-0.5V to +7.0V
DC Input Diode Current ( $I_{IK}$ ) $V_{IN} < 0V$	-50 mA
DC Output ( $I_{OUT}$ ) Sink Current	128 mA
DC $V_{CC}/GND$ Current ( $I_{CC}/I_{GND}$ )	$\pm 100$ mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C
Junction Lead Temperature under Bias ( $T_J$ )	+150°C
Junction Lead Temperature ( $T_L$ ) (Soldering, 10 Seconds)	+260°C
Power Dissipation ( $P_D$ ) @ +85°C	
SOT23-5	200 mW
SC70-5	150 mW

**Recommended Operating Conditions** (Note 3)

Power Supply Operating ( $V_{CC}$ )	1.65V to 5.5V
Control Input Voltage ( $V_{IN}$ )	0V to 5.5V
Switch Input Voltage ( $V_{IN}$ )	0V to $V_{CC}$
Switch Output Voltage ( $V_{OUT}$ )	0V to $V_{CC}$
Input Rise and Fall Time ( $t_r, t_f$ )	
Control Input; $V_{CC} = 2.3V-3.6V$	0 ns/V to 10 ns
Control Input; $V_{CC} = 4.5-5.5V$	0 ns/V to 5 ns
Switch I/O	0 ns/V to DC
Operating Temperature ( $T_A$ )	-40°C to +85°C
Thermal Resistance ( $\theta_{JA}$ )	
SOT23-5	300°C/Watt
SC70-5	425°C/Watt

**Note 1:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:** The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

**Note 3:** Unused inputs must be held HIGH or LOW. They may not float.

**DC Electrical Characteristics**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$			$T_A = +25^\circ\text{C}$			Units	Conditions
			Min	Typ (Note 5)	Max	Min	Typ	Max		
$V_{IH}$	HIGH Level Input Voltage	1.65 to 1.95	0.75 $V_{CC}$						V	
		2.3 to 5.5	0.7 $V_{CC}$							
$V_{IL}$	LOW Level Input Voltage	1.65 to 1.95			0.25 $V_{CC}$				V	
		2.3 to 5.5			0.3 $V_{CC}$					
$I_{IN}$	Control Input Leakage Current	0 to 5.5	$\pm 0.05$	$\pm 1.0$					$\mu A$	$0 \leq V_{IN} \leq 5.5V$
$I_{OFF}$	OFF Leakage Current	1.65 to 5.5	$\pm 0.05$	$\pm 10.0$					$\mu A$	$0 \leq A, B \leq V_{CC}$
$R_{ON}$	Switch On Resistance (Note 4)	4.5		3	7				$\Omega$	$V_{IN} = 0V, I_{IN} = 30 \text{ mA}$
				5	12					$V_{IN} = 2.4V, I_{IN} = 15 \text{ mA}$
				7	15					$V_{IN} = 4.5V, I_{IN} = 30 \text{ mA}$
		3.0		4	9					$V_{IN} = 0V, I_{IN} = 24 \text{ mA}$
				10	20					$V_{IN} = 3V, I_{IN} = 24 \text{ mA}$
		2.3		5	12					$V_{IN} = 0V, I_{IN} = 8 \text{ mA}$
				13	30					$V_{IN} = 2.3V, I_{IN} = 8 \text{ mA}$
		1.8		7	28					$V_{IN} = 0V, I_{IN} = 4 \text{ mA}$
				25	60					$V_{IN} = 1.8V, I_{IN} = 4 \text{ mA}$
$R_{flat}$	On Resistance Flatness (Note 4)(Note 6)(Note 7)	5.0				6			$\Omega$	$I_A = -30 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$
		3.3				12				$I_A = -24 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$
		2.5				28				$I_A = -8 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$
		1.8				125				$I_A = -4 \text{ mA}, 0 \leq V_{Bn} \leq V_{CC}$
$I_{CC}$	Quiescent Supply Current	1.65 to 5.5		0.05	10				$\mu A$	$V_{IN} = V_{CC} \text{ or } GND$ $I_{OUT} = 0$

**Note 4:** Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

**Note 5:** All typical values are at the specified  $V_{CC}$ , and  $T_A = 25^\circ\text{C}$ .

**Note 6:** Parameter is characterized but not tested in production.

**Note 7:** Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C, C <sub>L</sub> = 50 pF, R <sub>U</sub> = R <sub>D</sub> = 500Ω			Units	Conditions	Figure Number
			Min	Typ (Note 8)	Max			
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay Bus to Bus (Note 9)	1.65 to 1.95			4.3		V <sub>IN</sub> = OPEN	Figures 1, 2
		2.3-2.7			1.2	ns		
		3.0-3.6			0.8	ns		
		4.5-5.5			0.3	ns		
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time	1.65 to 1.95	1.5	7.0	14.2		V <sub>IN</sub> = 2 x V <sub>CC</sub> for t <sub>PZL</sub> V <sub>IN</sub> = 0V for t <sub>PZH</sub>	Figures 1, 2
		2.3-2.7	1.5	3.3	7.0	ns		
		3.0-3.6	1.5	2.4	5.5	ns		
		4.5-5.5	1.5	2.0	4.5	ns		
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time	1.65 to 1.95	1.5	9.2	18.2		V <sub>IN</sub> = 2 x V <sub>CC</sub> for t <sub>PLZ</sub> V <sub>IN</sub> = 0V for t <sub>PHZ</sub>	Figures 1, 2
		2.3-2.7	1.5	5.3	9.0	ns		
		3.0-3.6	1.5	4.0	7.0	ns		
		4.5-5.5	1.5	2.7	5.0	ns		

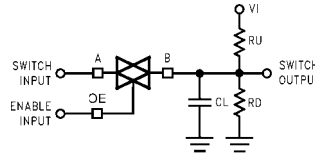
**Note 8:** All typical values are at the specified V<sub>CC</sub>, and T<sub>A</sub> = 25°C.

**Note 9:** This parameter is guaranteed by design but is not tested. The switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

## Capacitance

Symbol	Parameter	Typ	Max	Units	Conditions
C <sub>IN</sub>	Control Pin Input Capacitance	2		pF	V <sub>CC</sub> = 0V
C <sub>I/O</sub>	Input/Output Capacitance	6		pF	V <sub>CC</sub> = 5.0V

## AC Loading and Waveforms



Input driven by  $50\Omega$  source terminated in  $50\Omega$

$C_L$  includes load and stray capacitance.

Input PRR = 1.0 MHz;  $t_w = 500$  ns

FIGURE 1. AC Test Circuit

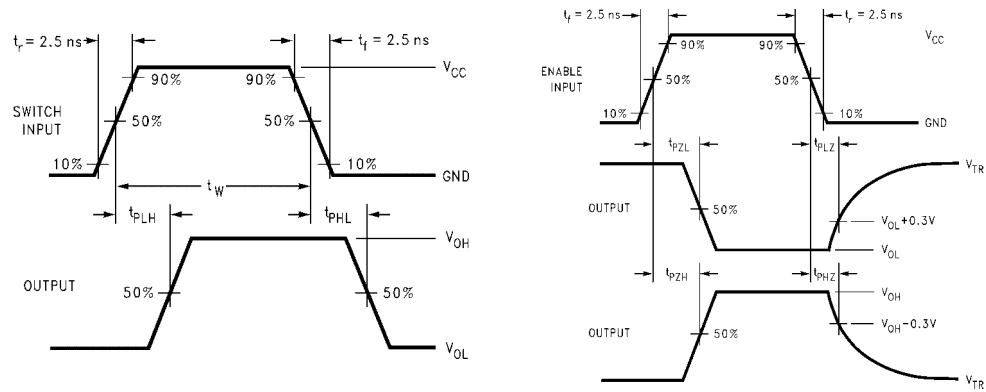


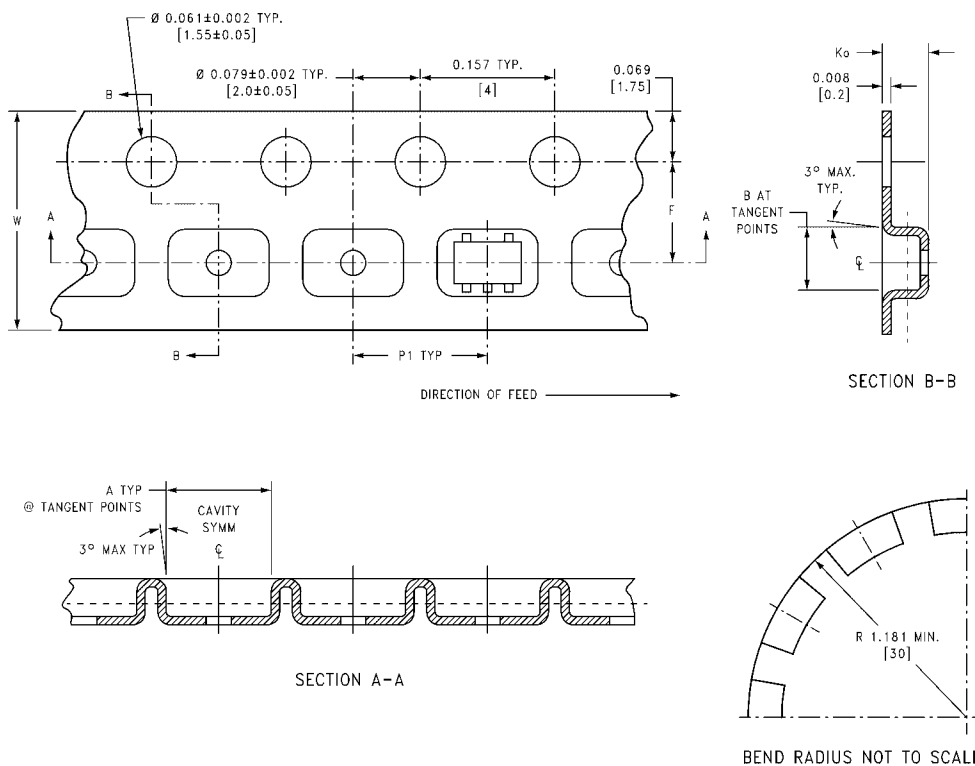
FIGURE 2. AC Waveforms

# Tape and Reel Specification

## TAPE FORMAT FOR SOT23, SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
M5X, P5X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

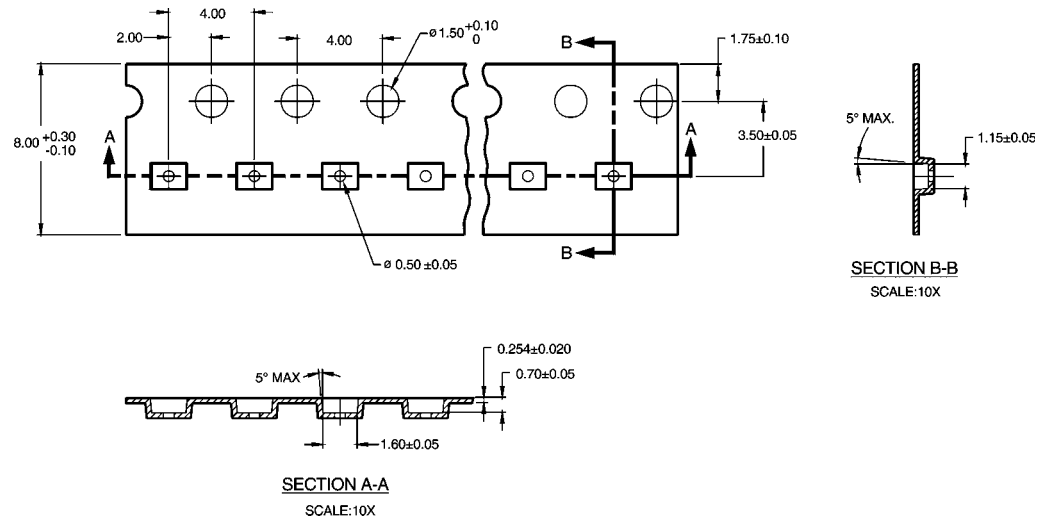
## TAPE DIMENSIONS inches (millimeters)



Package	Tape Size	DIM A	DIM B	DIM F	DIM K <sub>0</sub>	DIM P1	DIM W
SC70-5	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)
SOT23-5	8 mm	0.130 (3.3)	0.130 (3.3)	0.138 ± 0.002 (3.5 ± 0.05)	0.055 ± 0.004 (1.4 ± 0.11)	0.157 (4)	0.315 ± 0.012 (8 ± 0.3)

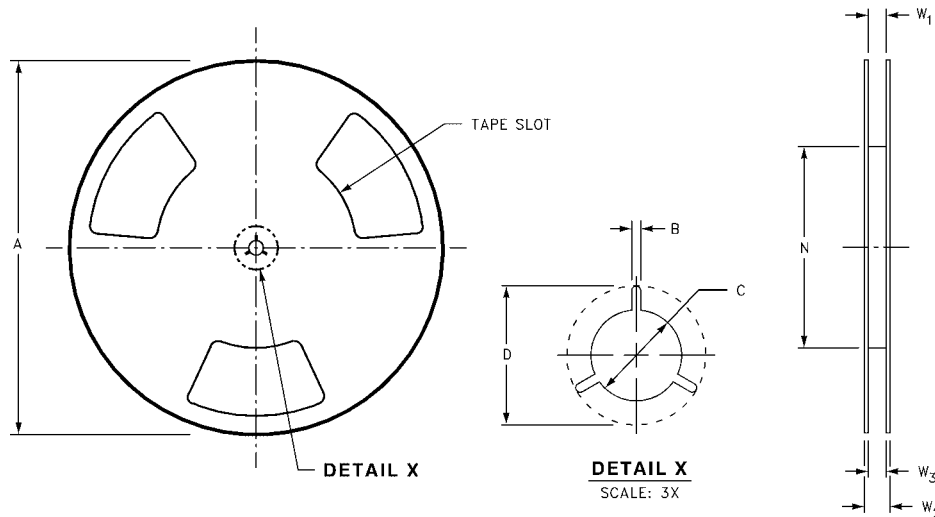
**Tape and Reel Specification** (Continued)**TAPE FORMAT FOR MicroPak**

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

**TAPE DIMENSIONS** inches (millimeters)

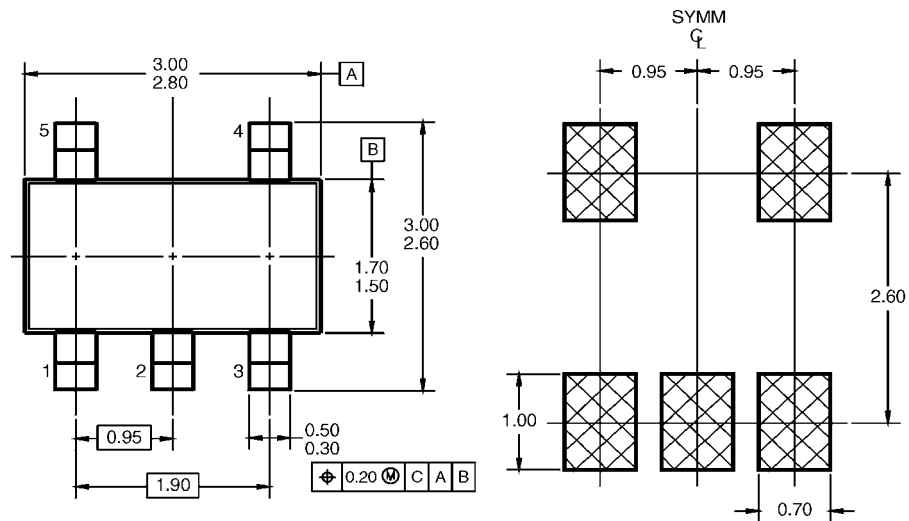
# Tape and Reel Specification (Continued)

REEL DIMENSIONS inches (millimeters)

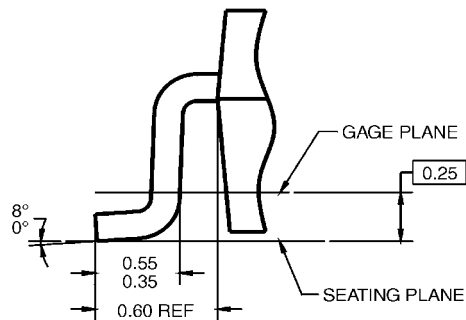
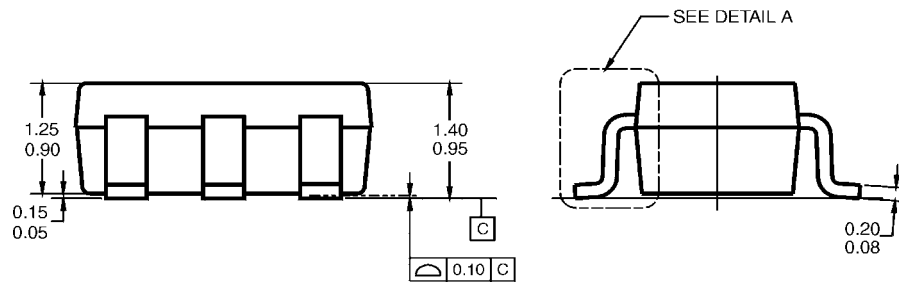


Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

# Physical Dimensions inches (millimeters) unless otherwise noted



## LAND PATTERN RECOMMENDATION



## NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC MO-178, ISSUE B, VARIATION AA, DATED JANUARY 1999.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

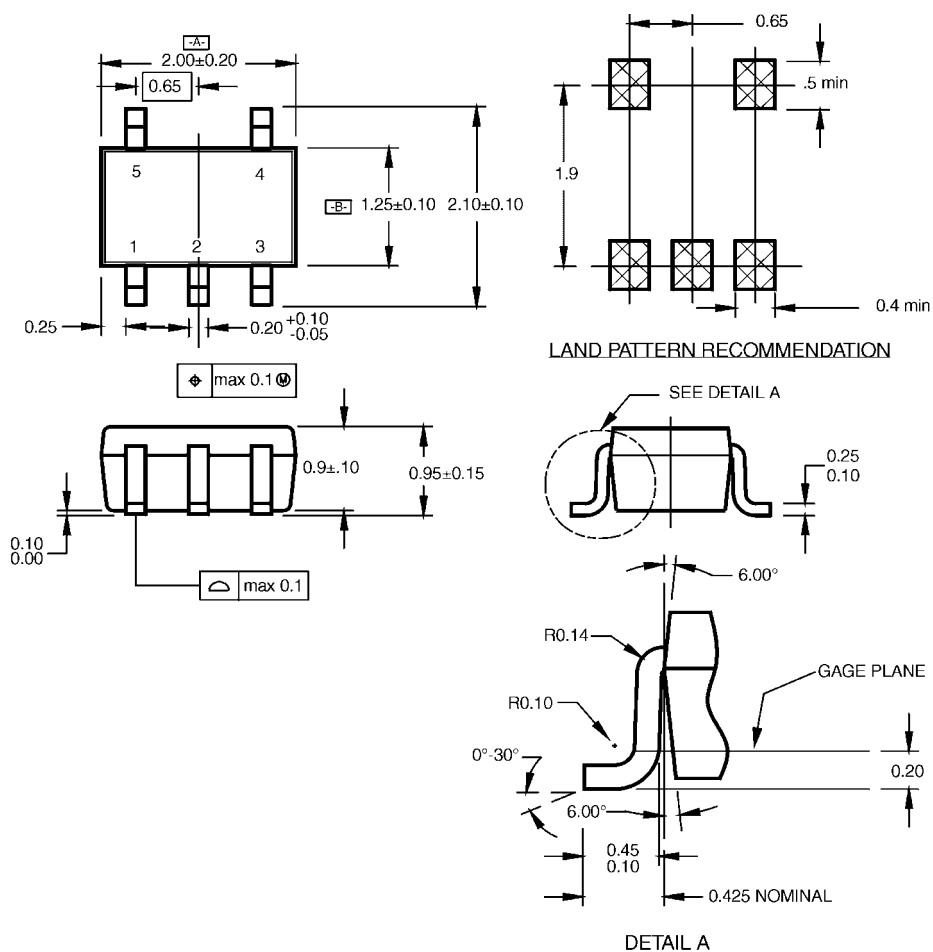
MA05BRevC

## DETAIL A

5-Lead SOT23, JEDEC MO-178, 1.6mm  
Package Number MA05B



**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



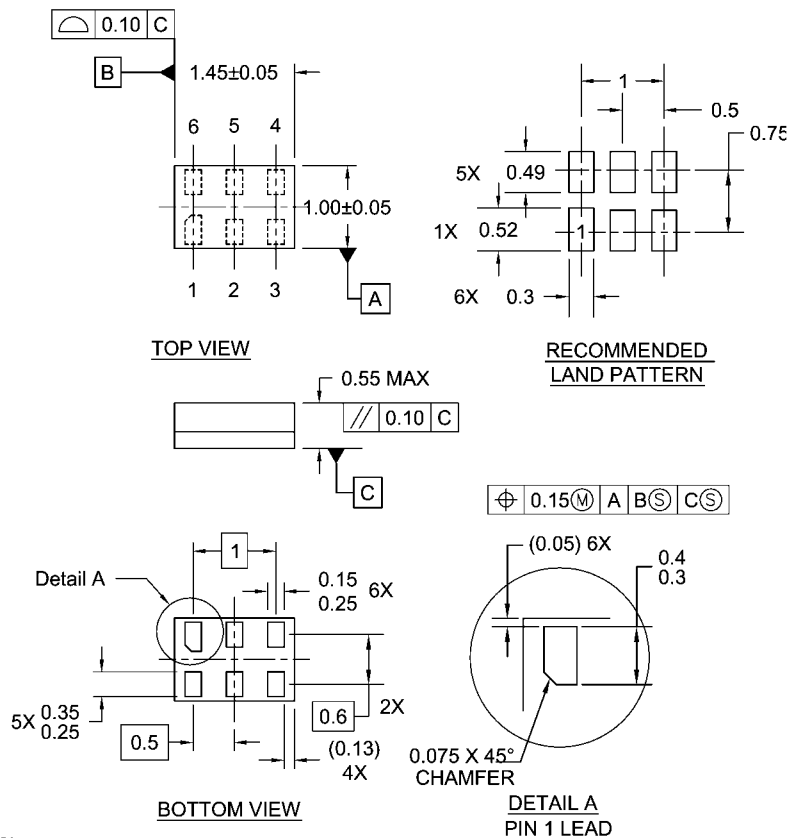
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

**5-Lead SC70, EIAJ SC-88a, 1.25mm Wide  
Package Number MAA05A**

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



### Notes:

1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

**6-Lead MicroPak, 1.0mm Wide  
Package Number MAC06A**

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